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Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Active
Core Processor	Z80
Number of Cores/Bus Width	1 Core, 8-Bit
Speed	16MHz
Co-Processors/DSP	-
RAM Controllers	-
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	-
Package / Case	100-QFP
Supplier Device Package	100-QFP
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z84c1516fsg

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Figure 4. Z84015/Z84C15 Pin-out Assignments

PIN DEFINITIONS

The pin assignment for each device is shown in Figures 3 and 4. Following is the description on each pin. For the description and the pin number, if stated as "x13" or "x15", that applies to both Z84C13/Z84013 or Z84C15/Z84015. Otherwise, C13 for Z84C13, C15 for Z84C15, 013 for Z84013 and 015 for Z84015.

CPU SIGNALS

Pin Name	Pin Number	Input/Output, 3-State	Function
AO-A15	16-1(x13), 6-1, 100-91(x15)	I/O	16-bit address bus. Specifies I/O and memory addresses to be accessed. During the refresh period, addresses for refreshing are output. The bus is an input when the external master is accessing the on-chip peripherals.
D0-D7	83-76(x13), 89-82(x15)	I/O	8-bit bidirectional data bus. When the on-chip CPU is accessing on-chip peripherals, these lines are set to output and hold the data to/from on-chip peripherals.
/RD	30(x13), 14(x15)	I/O	Read signal. CPU read signal for accepting data from memory or I/O devices. When an external master is accessing the on-chip peripherals, it is an input signal.
(WŖ	20(x13), 13(x15)	I/O	Write Signal. This signal is output when data, to be stored in a specified memory or peripheral LSI, is on the MPU data bus. When an external master is accessing the on-chip peripherals, it is an input signal.
/MREQ	23(x13), 17(x15)	I/O, 3-State	Memory request signal. When an effective ad- dress for memory access is on the address bus, "0" is output. When an external master is accessing the on-chip peripherals, it is an tri- state signal.
/IORQ	21(x13), 15(x15)	I/O	I/O request signal. When addresses for I/O are on the lower 8 bits (A7-A0) of the address bus in the I/O operation, "0" is output. In addition, the /IORQ signal is output with the /M1 signal at the time of interrupt acknowledge cycle to inform peripheral LSI of the state of the interrupt response vector is when put on the data bus. When an external master is accessing the on- chip peripherals, it is an input signal.
/M1	17(x13), 8(x15)	I/O	Machine cycle "1". <i>I</i> MREQ and "0" are putput together in the operation code fetch cycle. <i>I</i> M1 is output for every opcode fetch when a two byte opcode is executed. In the maskable interrupt acknowledge cycle, this signal is output together with <i>I</i> IORQ. It is 3-stated in EV mode.

CPU SIGNALS (Continued)

Pin Name	Pin Number	Input/Output, 3-State	Function
A7RF	55(x13), 70(x15)	Out	1-bit auxiliary address bus. Output is the same as bit-7 (A7) of the address bus. However, during a refresh cycle, this pin outputs the address which is the most significant bit of the 8-bit refresh address signal linked to the low order 7 bits of the address bus.

CTC SIGNALS

Pin Name	Pin Number	Input/Output, 3-State	Function
CLK/TRG0 - CLK/TRG3	75-72(x13), 81-78(x15)	In	External clock/trigger input. These four CLK/ TRG pins correspond to four Counter/Timer Channels. In the counter mode, each active edge will cause the downcounter to decrement by one. In timer mode, an active edge will start the timer. It is program selectable whether the active edge is rising or falling.
ZC/TO0 - ZC/TO3	68-71(x13), 74-77(x15)	Out	Zero count/timer out signal. In either timer or counter mode, pulses are output when the down-counter has reached zero.

SIO SIGNALS

Pin Name	Pin Number	Input/Output, 3-State	Function
/W//RDYA, /W//RDYB	32,54(x13), 30,52(x15)	Out	Wait/Ready signal A and Wait/Ready signal B. Used as /WAIT or /READY depending upon SIO programming. When programmed as /WAIT they go active at "0", alerting the CPU that addressed memory or I/O devices are not ready by requesting the CPU to wait. When programmed as /READY, they are active at "0" which determines when a peripheral device associated with a DMA port is for read/write data.
/SYNCA, /SYNCB	33,53(x13), 31,51(x15)	I/O	Synchronous signals.In asynchronous receive mode, they act as /CTS and /CDC. In external sync mode, these signals act as inputs. In internal sync mode, they act as outputs.
RxDA, RxDB	34,52(x13), 32,50(x15)	In	Serial receive data signal.



Figure 5(a). Block Diagram for 84013/015 IPC

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Figure 6. PiO Block Diagram





Z84C4x Serial I/O Logic Unit

This logic unit provides the user with two separate multiprotocol serial I/O channels that are completely compatible with the Z84C4x SIO. Their basic functions as serial-toparallel and parallel-to-serial converters can be programmed by a CPU for a broad range of serial communications applications. Each channel, designated Channel A and Channel B, is capable of supporting all common

asynchronous and synchronous protocols (Monosync, Bisync, and SDLC/HDLC, byte or bit oriented - Figure 8).

Z84C13/C15 Only. As an enhancement to the Z84013/015, the Z84C13/C15 can handle a 32-bit CRC on Channel A and Schmitt-trigger inputs on the /TxC and /RxC pins of both channels.



Figure 8. SIO Block Diagram

Watch Dog Timer (WDT) Logic Unit

This logic unit has been superintegrated into the IPC. It detects an operation error, caused by the program runaway, and returns to normal operation. Figure 9, shows the block diagram of the WDT. Upon Power-On Reset, this unit is enabled. If WDT is not required, but /WDTOUT is connected to /RESET or any other circuit, it has to be disabled. During the power-down mode of operation (either IDLE1/ 2 or Stop), the Watch Dog Timer is halted.

WDT Output (/WDTOUT pin). When the WDT is used, the "0" level signal is output from the /WDTOUT pin after a duration of time specified in the WDTP or in the WDTMR. The output pulse width is one of the following, depending on the /WDTOUT pin connection.

- The /WDTOUT is connected to the /RESET pin: The "0" level is pulsed for 5TcC (System clock cycles).
- The /WDTOUT is connected to a pin other than the /RESET pin: The "0" level is kept until the Watch Dog timer is cleared by software, or reset by /RESET pin.

CGC Logic Unit. The IPC has CGC (Clock Generator/ Controller) unit. This unit is identical to the one with the Z84C01 and the Z84C50, and supports power-down modes of operation. The output from this unit is on the pln called CLKOUT, and is not connected to the system clock internally. The CLKIN pin is the system clock input. The user can connect CLKOUT to CLKIN to utilize this CGC unit, or supply external clock from CLKIN pin.

The CGC unit allows crystal input (XTAL1, XTAL2) or External Clock input on the XTAL1 pin. It has clock divideby-two circuits and generates a half-speed clock to the input.

Z84C13/C15. The power-down modes of the IPC vary depending upon whether the system clock is fed from the CGC unit (tie CLKOUT to CLKIN) or the external clock source on the CLKIN pin. They also have divide-by-one Mode. If the clock is supplied by this CGC unit, all of the modes in "halt" state are available. When external clock is provided on the CLKIN pin, XTAL1 is not left open (tied to "0" or "1") to avoid meta-stable conditions to minimize power consumption.

Addrees	 Doution	Channal	Posistor
	Device		
10h	CTC	Ch 0	Control Register
11h	CTC	Ch 1	Control Register
12h	CTC	Ch 2	Control Register
13h	CTC	Ch 3	Control Register
18h	SIO	Ch. A	Data Register
19h	SIO	Ch. A	Control Register
1Ah	SIO	Ch. B	Data Register
1Bh	SIO	Ch. B	Control Register
1Ch	PIO	Port A	Data Register (Not with Z84x13)
1Dh	PIO	Port A	Command Register (Not with Z84x13)
1Eh	PIO	Port B	Data Register (Not with Z84x13)
1Fh	PIO	Port B	Command Register (Not with Z84x13)
F0h	Watch-Dog Time	er	Master Register (WDTMR)
Fth	Watch-Dog Time	er 🛛	Control Register (WDTCR)
F4h	Interrupt Priority	Register	· · ·
EEh			System Control Register Pointer (SCRP)
			(Not with Z84013/015)
EFh			System Control Data Port (SCDP) (Not
			with Z84013/015)
	Through SCRP a	Ind SCDP	Control Register 00 - Wait State Control
			register (WCR)
			Control Register 01 - Memory Wait state
			Boundary Register (MWBR)
			Control Register 02 - Chip Select Boundary
			Register (CSBR)
			Control Register 03-Misc. Control Register

PIO REGISTERS

For more detailed information, please refer to the PIO Technical Manual. These registers are not in the Z84x13.

Interrupt Vector Word

The PIO logic unit is designed to work with the Z80 CPU in interrupt Mode 2. The interrupt word must be programmed if interrupts are used. Bit D0 must be a zero (Figure 11).



Figure 11. PIO Interrupt Vector Word



D7 = 0 Interrupt Disable D7 = 1 Interrupt Enable

Figure 16. Interrupt Disable Word

CTC CONTROL REGISTERS

For more detailed information, refer to the CTC Technical Manual.

Channel Control Word

This word sets the operating modes and parameters as described below. Bit D0 is a "1" to indicate that this is a Control Word (Figure 17).





* Timer Mode Only

Figure 17. CTC Channel Control Word

Bit D7. Interrupt Enable. This bit enables the interrupt logic so that an internal INT can be generated at zero count. Interrupts are programmed in either mode and may be enabled or disabled at any time.

Bit D6. Mode Bit. This bit selects either Timer Mode or Counter Mode.

Bit D5. Prescalor Factor. This bit selects the prescalor factor for use in the timer mode. Either divide-by-16 or divide-by-256 is available.

Bit D4. Clock/Trigger Edge Selector. This bit selects the active edge of the CLK/TRG input pulses.

Bit D3. Timer Trigger. This bit selects the trigger mode for timer operation. Either automatic or external trigger may be selected.

Bit D2. Time Constant. This bit indicates that the next word programmed is time constant data for the downcounter.

Bit D1. Software Reset. Writing 1 to this bit indicates a software reset operation, which stops counting activities until another time constant word is written.

Time Constant Word

Before a channel starts counting, it must receive a time constant word. The time constant value is anywhere between 1 and 256, with "0" being accepted as a count of 256 (Figure 18).



Figure 18. CTC Time Constant Word

Interrupt Vector Word

If one or more of the CTC channels have interrupt enabled, then the Interrupt Vector Word must be programmed. Only the five most significant bits of this word are programmed, and bit D0 must be "0". Bits D2-D1 are automatically modified by the CTC channels when it responds with an interrupt vector (Figure 19).

Table 3. Device status in Halt state (When using on-chip CGC unit; CLKOUT and CLKIN are tied together)								
Mode	CGC	CPU	стс	PЮ	SIO	WDT	CLKOUT	
idle1 idle2 stop run	0 0 X 0	X X X O	X O X O	X X X O	X X X O	X X X O	X O X O	

All of the operating modes listed here are valid with crystal input (Crystal connected between XTAL1/2 or external clock input on XTAL1). For the external clock on the CLKIN pin, only the IDLE2 and RUN modes are applicable.

O: Operating X: Stop

TIMING

Basic Timing

The basic timing is explained here with emphasis placed on the halt function relative to the clock generator. The following items are identical to those for the Z84C00. Refer to the data sheet for the Z84C00.

- Operation code fetch cycle
- Memory Read/Write operation
- Input/Output operation
- Bus request/acknowledge operation
- Maskable interrupt request operation
- Non-Maskable interrupt request operation
- Reset Operation

Operation When HALT Instruction is Executed. When the CPU fetches a halt instruction in the operation code fetch cycle, /HALT goes active (Low) in synch with the falling edge of T4 state before the peripheral LSI and CPU stops the operation. After this, the system clock generation differs depending upon the operation mode (RUN Mode, IDLE 1/2 Mode or STOP Mode). If the internal system clock is running, the CPU continues to execute NOP instruction even in the halt state.

RUN Mode (HALTM = 11). Shown in Figure 31 is the basic timing when the halt instruction is executed in RUN Mode.



Figure 31. Timing of RUN Mode (at Halt Instruction Command Execution)

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In IDLE2 Mode, the internal oscillator and clock output (CLKOUT) continue to operate. The internal system clock, fed from CLKIN to the components other than CTC is stopped at the T4 Low state of HALT instruction execution.

STOP Mode (HALTM=10). Shown in Figure 34 is the basic timing when the halt instruction is executed in STOP Mode.



(At Halt Instruction Execution)

In STOP Mode, the on-chip CGC unit is stopped at T4 Low state of HALT instruction execution. Therefore, clock output (CLKOUT), operation of Watch Dog Timer, CPU, PIO, CTC, SIO are stopped.

Release from Halt State. The halt state of the CPU is released when "0" is input to the /RESET signal and the MPU is reset or an interrupt request is accepted. An interrupt request signal is sampled at the leading edge of the last clock cycle (T4 state) of NOP instruction. In case of the maskable interrupt, interrupt will be accepted by an active /INT signal ("0" level). Also, the interrupt enable flipflop is set to "1". The accepted interrupt process is started from the next cycle.

Further, when the internal system clock is stopped (IDLE 1/ 2 Mode, STOP Mode), it is necessary first to restart the internal system clock. The internal system clock is restarted when /RESET or interrupt signal (/NMi or /INT) is asserted.

RUN Mode (HALTM=11). The halt release operation is enabled by interrupt request in RUN Mode (Figure 35).



Figure 36. Halt Release Operation Timing By Reset in RUN Mode

IDLE1 Mode (HALTM=00), IDLE2 Mode (HALTM=01). The halt release operation by interrupt signal in IDLE1 Mode is shown in Figure 37 (a) and in IDLE2 Mode in Figure 37 (b).

When receiving /NMI or /INT signals, the stopped internal system clock starts to feed. In IDLE1 Mode, the IPC starts clock output on CLKOUT at the same time.

The operation stop of CPU in IDLE2 mode is taking place at "0" level during T4 state in the halt instruction op-code fetch cycle. Therefore, after being restarted by the interrupt signal, CPU executes one NOP instruction and samples an interrupt signal at the rise of T4 state during the execution of this NOP instruction, and executes the interrupt process from next cycle. If no interrupt signal is accepted during the execution of the first NOP instruction after the internal system clock is restarted, CPU is not released from the halt state. It is placed in IDLE 1/2 Mode again at "0" level during T4 state of the NOP instruction, stopping the internal system clock. If /INT signal is not at "0" level at the rise of T4 state, no interrupt request is accepted.

The halt release operation resets the IPC in IDLE1 Mode (Figure 38a) and in IDLE2 Mode (Figure 38b).



Figure 38. Halt Release Operation Timing By Reset in IDLE1/2 Mode

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Z84C13/C15 Only. The /RESET pulse is stretched to a minimum of 16 cycles and driven out of the Z84C13/C15 on the /RESET pin if Reset output is enabled (bit D3 of MCR is cleared to "0"). Setting bit D3 disables the driving out of

/RESET. The values in the control registers (WDTMR, SCRP, WCR, MWBR, CSBR and MCR) are initialized to the default value on /RESET.



Figure 40. Hait Release Operation Timing By Reset in STOP Mode

Start-up Time at Time of Restart (STOP Mode). When the MPU is released from the halt state by accepting an interrupt request, it executes an interrupt service routine. Therefore, when an interrupt request is accepted, it starts generating clock on the CLKOUT pin, after a start-up time, by the internal counter [(2¹⁴+2.5) TcC (TcC:Clock Cycle)]. This obtains a stabilized oscillation for operation.

Further, in case of restart by the /RESET signal, the internal counter does not operate.

Evaluation operation. Each of the CPU signals (A15-0, D7-0, /MREQ, /IORQ, /RD, /WR, /HALT, /M1, /RFSH) can be 3-stated by activating the EV pin. The Z84C13/C15 enhances the counter part by eliminating the requirement of /BUSREQ to go active.

Instruction set. The instruction set of the IPC is the same for the Z84C00. For details, refer to the data sheet of the Z84C00 Technical Manual.

AC TIMING

The following section describes the timing of the IPC. The numbers appearing in the figures refer to the parameters on Table A - F.

CPU Timing

Parameters referenced in Figure 41 through Figure 48 appear in Table A.

The IPC's CPU executes instructions by proceeding through the following specific sequence of operations: Memory read or write I/O device read or write Interrupt acknowledge

The basic clock period is referred to as a Time or Cycle and three or more T cycles make up a machine cycle (e.g., M1, M2 or M3). Machine cycles are extended either by the CPU automatically inserting one or more Wait states or by the insertion of one or more Wait states by the user. **Interrupt Request/Acknowledge Cycle.** The CPU samples the interrupt signal with the rising edge of the last clock cycle at the end of any instruction (Figure 44). When an interrupt is accepted, a special /M1 cycle is generated.

During this /M1 cycle, /IORQ becomes active (instead of /MREQ) to indicate that the interrupting device can place an 8-bit vector on the data bus. The CPU automatically adds two Wait states to this cycle.



NOTE: 1) T = Last state of any instruction cycle

2) T_{WA} = Wait cycle automatically inserted by CPU

Figure 44. Interrupt Request/Acknowledge Cycle (See Table A)



Halt acknowledge cycle. Figure 47 shows the timing for Halt acknowledge cycle.

Although /NMI is an asynchronous input, to guarantee its being recognized on the following machine cycle, /NMI's falling edge must occur no later than the rising edge of the clock preceding the last state of any instruction cycle (TLI).

Figure 47. Halt Acknowledge (See Table A)

Reset Cycle. /RESET must be active for at least three clock cycles for the CPU to properly accept it. As long as /RESET remains active, the address and data buses float, and the control outputs are inactive.

Once /RESET goes inactive, two internal T cycles are consumed before the CPU resumes normal processing operation. /RESET clears the PC register, so the first op-code fetch location is 0000H (Figure 48).

Z84C13/C15 Only. If Reset output is disabled, /RESET must be active for at least three clock cycles for the CPU to properly accept it. Otherwise, /RESET must be active for at least two clock cycles and the on-chip reset circuit extends /RESET signal to at least a minimum of 16-clock cycles.



* 84C13/15 Only Reset Output is Enabled

Figure 48. Reset Cycle (See Table A)

CTC Timing Figure 55 shows the timing for on-chip CTC.



Figure 55. Counter/Timer Timing (See Table E)

AC CHARACTERISTICS (Continued)

		· · · · · · · · · · · · · · · · · · ·	Z84C1306	Z84C1310	Z84C1316*	·	
No	Symbol	Doromotor	Z84C1506	Z84C1510	Z84C1516		
			MILI Max	Min Max	Min Max	Unit	Note
1	TRST(INT)S	Clock Restart Time by /INT (STOP Mode)	(Typ)214+2.5TcC	(Typ)2 ¹⁴ +2.5TcC	(Typ)2 ¹⁴ +2.5TcC	ns	
2	TRST(MNI)S	Clock Restart Time by /NMI (STOP Mode)	(Typ)214+2.5TcC	(Typ)2 ¹⁴ +2.5TcC	(Typ)2 ¹⁴ +2.5TcC	ns	
3	TRST(INT)I	Clock Restart Time by /INT (IDLE Mode)	2.5TcT	2.5TcT	2.5TcT	ns	
4	TRST(Nmi)I	Clock Restart Time by /NMI (IDLE Mode)	2.5TcT	2.5TcT	2.5TcT	ns	
5	TRST(RESET)	Clock Restart Time by /RESET (IDLE Mode)	1TcC	1TcC	1TcC	ns	
6	TICLKOUT	CLKOUT Rise Time	15	10	6	20	
7	TrCLKOUT	CLKOUT Fall time	15	10	6	ns	
8	TcX1	XTAL1 Cycle Time (for External Clock Input on XTAL1)					-+
		Divide-by-Two Mode	81	50	31	ns	
		Divide-by-One Mode	162	100	61	ns	
9	TwiX1	XTAL1 Low Pulse Width (for External Clock Input on XTAI 1)					
		Divide-by-Two Mode	35	15	10	ns	
		Divide-by-One Mode	65	40	25	ns	
10	TwhX1	XTAL1 High Pulse Width (for External Clock input on XTAL1)					•
		Divide-by-Two mode	35	15	10	ns	
		Divide-by-One mode	65	40	25	ns	
11	TrX1	XTAL1 Rise Time (for External Clock Input on XTAI 1)	25	25	15	ns	(B1)
12	TfX1	XTAL1 Fall Time (for External Clock Input on XTAL1)	25	25	15	ns	(B1)

Table B. CGC Timing (See Figure 49 to 52)

Note: [B1] If parameters 8 and 9 are not met, adjust parameters 11 and 12 to satisfy parameters 8 and 9.

			Z84C1306		Z84C1310		Z84C1316*			
No	Symbol	Parameter	Min	Max	Min	Max	204C Min	Max	Unit	Note
1	TsA(Rtf)	Address Setup Time to /RD, /IORQ Fall	50		40		30		ns	
2	TsRI(Cr)	/RD, /IORQ Rise to Clock Rise Setup	60		50		40		ns	
3	Th	Hold time for Specified Setup	15		15		10		ns	
4	TdCr(DO)	Clock Rise to Data out delay	-	100		80	60		ns	
5	TdRir(DOz)	/RD, /IORQ Rise to Data Out Float Delay		75		60	50		ns	
6	ThRDr(D)	/M1, /RD, /IORQ Rise to Data Hold	15	. 40	15	30		20	ns	(C1)
7	TsD(Cr)	Data In to Clock Rise Setup Time	30		25		15		ns	
8	TdlOf(DOI)	/IORQ Fall to Data Out Delay (INTACK cycle)		95		95	70		ns	
9	ThiOr(D)	/IORQ Rise to Data Hold	15		15		10		ns	
10	ThIOr(A)	/IORQ Rise to Address Hold	15		15		10		 П\$	
11	TsWII(Cr)	/IORQ, /WR setup time to Clock Rise New parameter	20		20		15		ns	[C2]
12	ThWRr(Cr)	Clock Rise to /IORQ, /WR Rise hold time	0		0		0		ns	[C2]
13	TsM1f(Cr)	/M1 Fall to Clock Rise Setup Time	40		40	· · ·	15		ns.	
14	TsM1r(Cf)	/M1 Rise to Clock Rise Setup Time (/M1 cycle)	-15		-15		-10		ns	
15	TdM1f(IEOf)	/M1 Fall to IEO Fall delay								
		(Interrupt Immediately Preceding /M1 Fall)		140		80		60	ns	
20	TdCf(IEOr)	Clock Fall to IEO Rise Delay	50		40	· · · · · · · · · · · · · · · · · · ·		30	ns	
21	TdCf(IEOf)	Clock Fall to IEO Rise Detay		90		75		50	ns	

.

Table C. Timing for on-chip peripheral access from external bus master and daisy chain timing (See Figure 53(a))

Notes: [C1] For I/O write to PIO, CTC and SIO. [C2] For I/O Write to system control registers. [C3] For daisy-chain timing, please refer to the note on Page 356.

				Z84C1306 Z84C1506		Z84C1310 Z84C1510		Z84C1316* Z84C1516		
No	Symbol	Parameter	Min	Max	Min	Max	Min	Max	Unit	Note
1	TwPh	Pulse Width (High)	150		120		80		ns	
2	TwPl	Pulse Width (Low)	150		120		80		ns	
3	TcTxC	/TxC Cycle Time	250		200		120		ns	[F1]
4	TwTxCH	/TxC Width (High)	85		80		55		ns	
5	TwTxCL	/TxC Width (Low)	8 5		80		55		ns	
6	TrTxC	/TxC Rise Time		60		60		60	ns	
7	TfTxC	/TxC Fall Time		60		60		60	ns	
8	TdTxCf(TxD)	/TxC Fall to TxD Delay		160		120		40	ns	
9	TdTxCf(W/RRf) (Ready Mode)	/TxC Fall to /W//RDY Fall Delay	5	9	5	9	5	8	TcC	
10	TdTxCf(INTf)	/TxC Fall to /INT Fall Delay	5	9	5	9	5	9	TcC	
11	TcRxC	/RxC Cycle Time	250		200		120		กร	(F1)
12	TwRxCh	/RxC Width (High)	85		80		55		ns	
13	TwRxCl	/RxC Width (Low)	85		80		55		ΠS	
14	TrRxC	/RxC Rise Time		60		60		60	ПS	
15	TfRxC	/RxC Fall Time		60		60		60	ns	
16	TsRxD(RxCr)	RxD to /RxC Rise Setup Time (X1 Mode)	0		0		0		ns	
17	ThRxCr(RxD)	/RxC Rise to RxD Hold Time (X1 Mode)	80		60			,40	ns	
18	TdRxCr(W/RRf)	/RxC Rise to /W//RDY Fall Delay (Ready Mode)	10	13	10	13	10	13	TcC	
19	TdRxCr(INTf)	/RxC Rise to /INT Fall Delay	10	13	10	13	10	13	TcC	
20	TdRxCr(SYNCf)	/RxC Rise to /SYNC Fall Delay (Output Modes)	4	7	4	7	4	7	TcC	
21	TsSYNCI(RxCr)	/SYNC Fall to /RxC Rise Setup (External Sync Modes)	-100		-100		-100		ns	[F2]
22	TdlOf(W/RRf)	/IORQ Fall or Valid Address to /W//RDY Delay (Wait Mode)		130		110		40	ns	[F2]
23	TdCr(W/RRf)	Clock Rise to /W//RDY Delay (Ready Mode)		85		85		40	ΠS	[F2]
24	TdCf(W/Rz)	Clock Fall to /W//RDY Float Delay (Wait Mode)		90		80		40	NS	(F2)

.

Notes: [F1] In all modes, the System Clock rate must be at least five times the maximum data rate. [F2] Parameters 22 to 24 are on Figure 53a.